LNX898LKDAC

Round Type

φ3.0 mm

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit				
Power dissipation	P _D	90	mW				
Forward current	I _F	30	mA				
Pulse forward current *	I _{FP}	150	mA				
Reverse voltage	V _R	3	V				
Operating ambient temperature	T _{opr}	-25 to +85	°C				
Storage temperature	T _{stg}	-30 to +100	°C				

Lighting Color

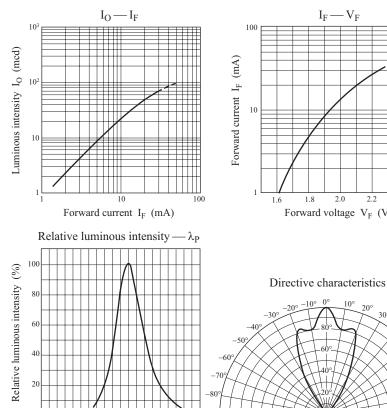
• Orange

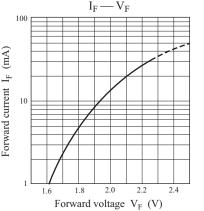
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

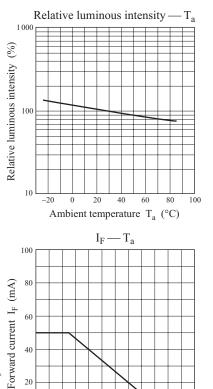
Electro-Optical Characteristics $T_a = 25^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *	I _O	$I_{\rm F} = 20 {\rm mA}$	20.0	50.0		mcd
Reverse current	I _R	$V_R = 3 V$			10	μΑ
Forward voltage	V _F	$I_{\rm F} = 20 \ {\rm mA}$		2.1	2.8	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_{\rm F} = 20 {\rm mA}$		630		nm
Spectral half band width	Δλ	$I_{\rm F} = 20 {\rm mA}$		40		nm

Note) *: Measurement tolerance: ±20%





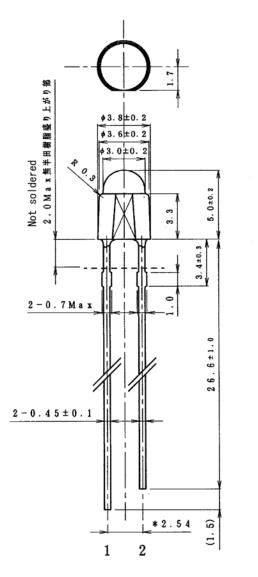


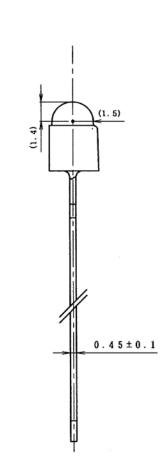
80°

Peak emission wavelength λ_P (nm)

Ambient temperature T_a (°C)

Package (Unit: mm)





• Pin name

1: Anode

2: Cathode

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